



PDP design and Thermal issue

林清輝

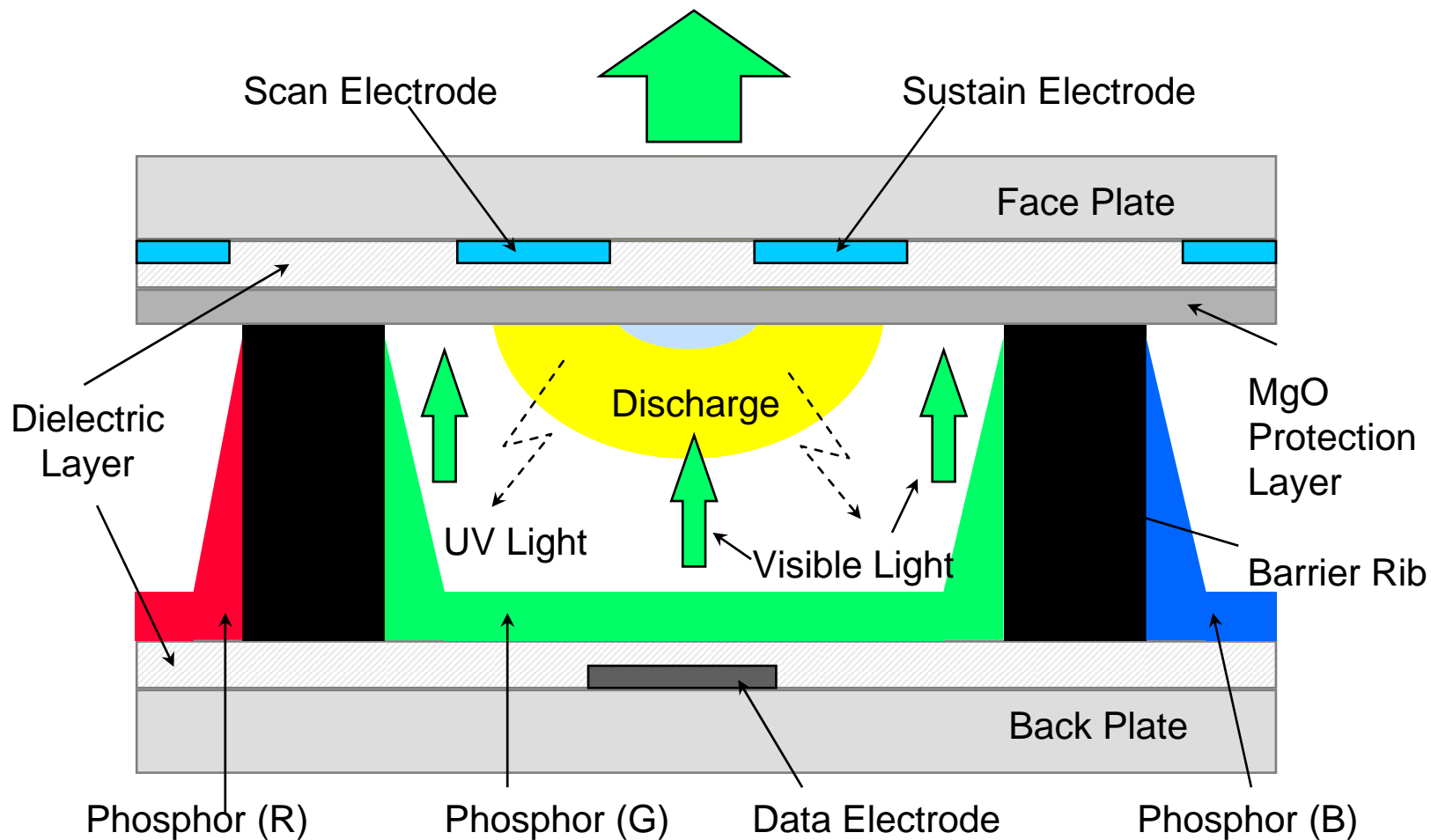
michaellin@ddmccn.com

linchue@mail.cptt.com.tw



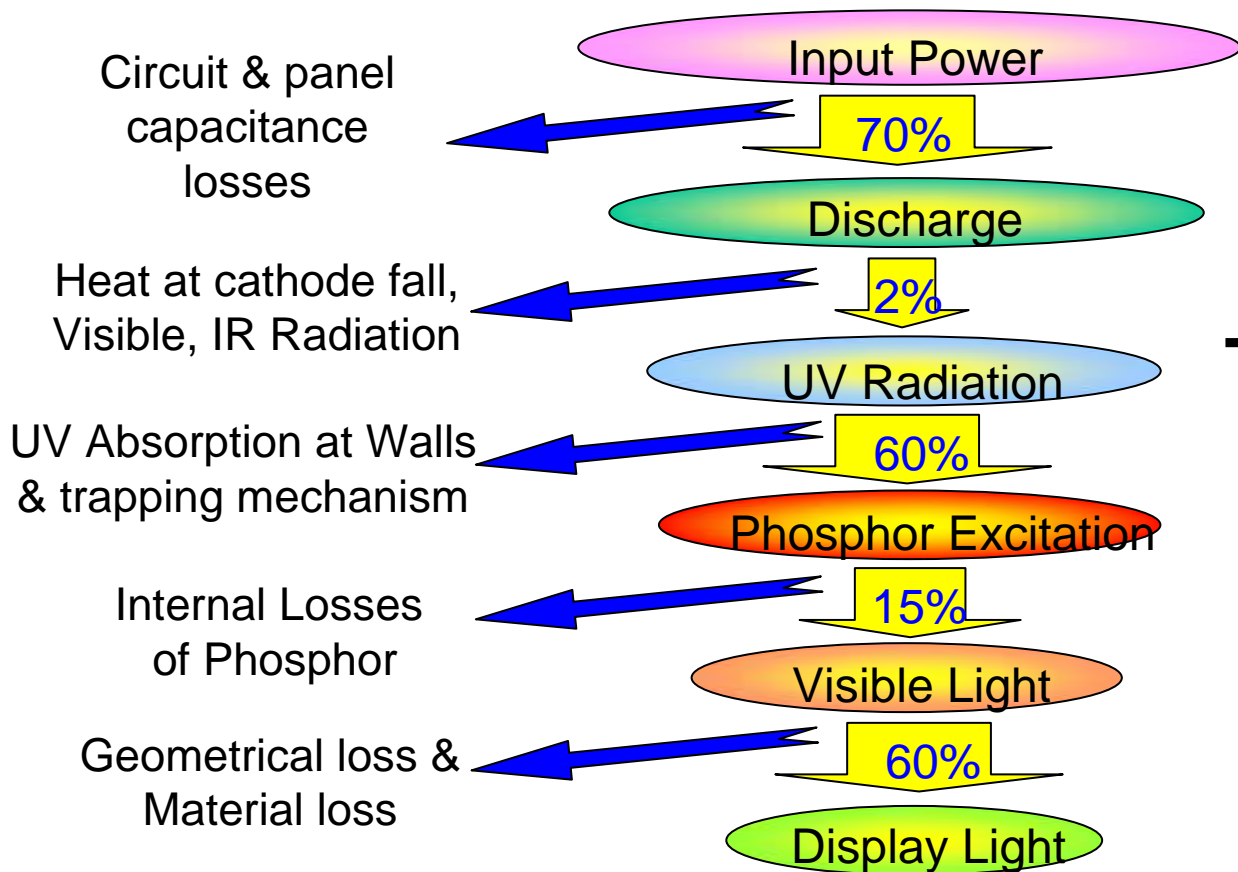


PDP panel structure





Total Efficiency of PDP



**Total Efficiency
of PDP=0.15%**

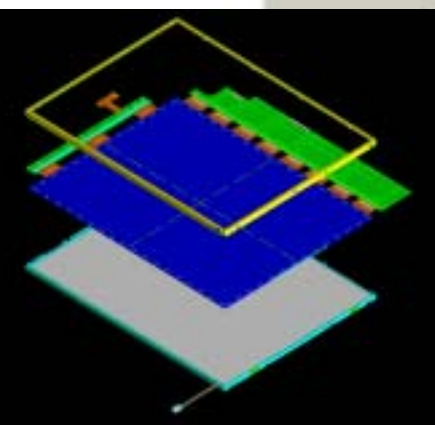
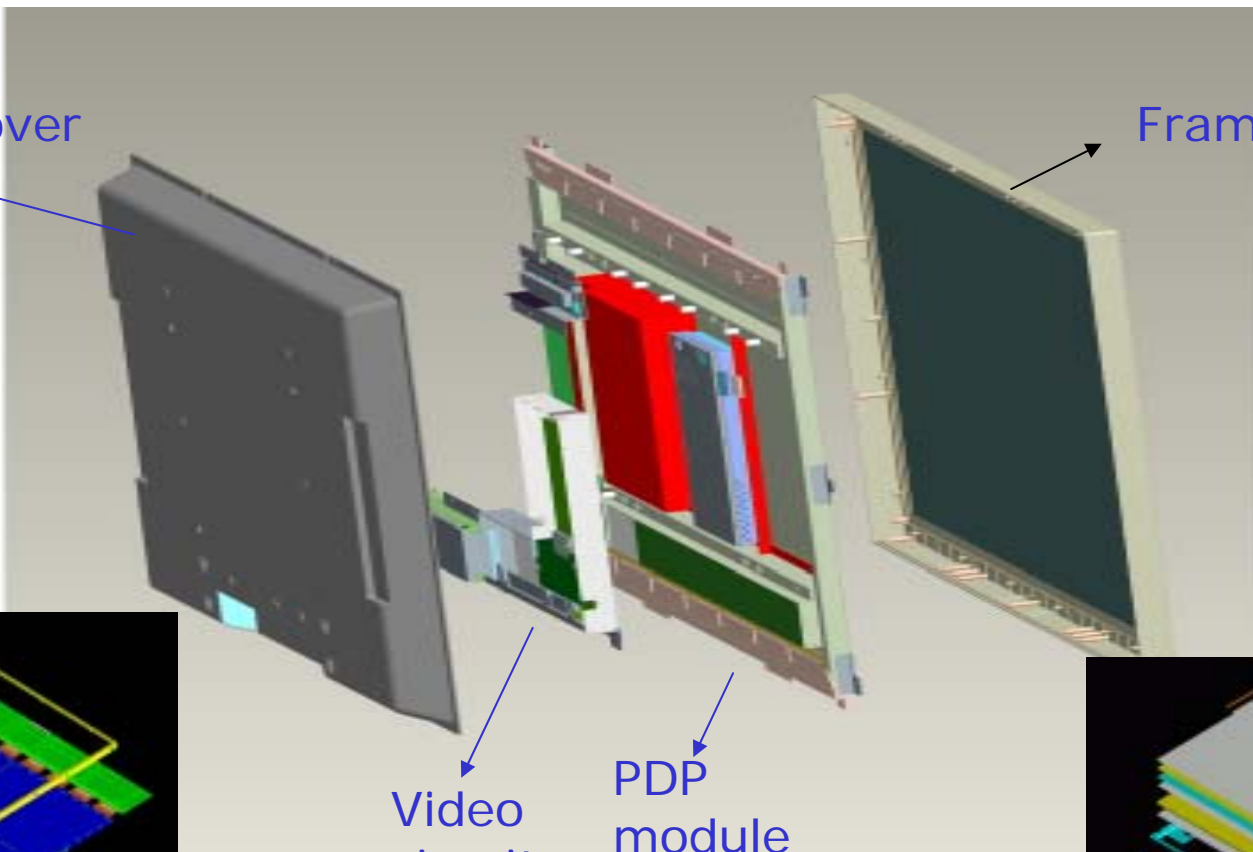
2.0 lm/W



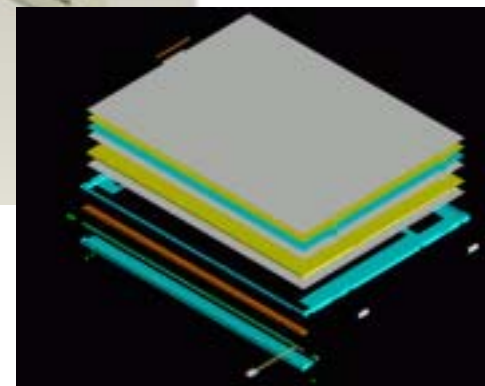
Main PDP TV parts

Backcover

Frame



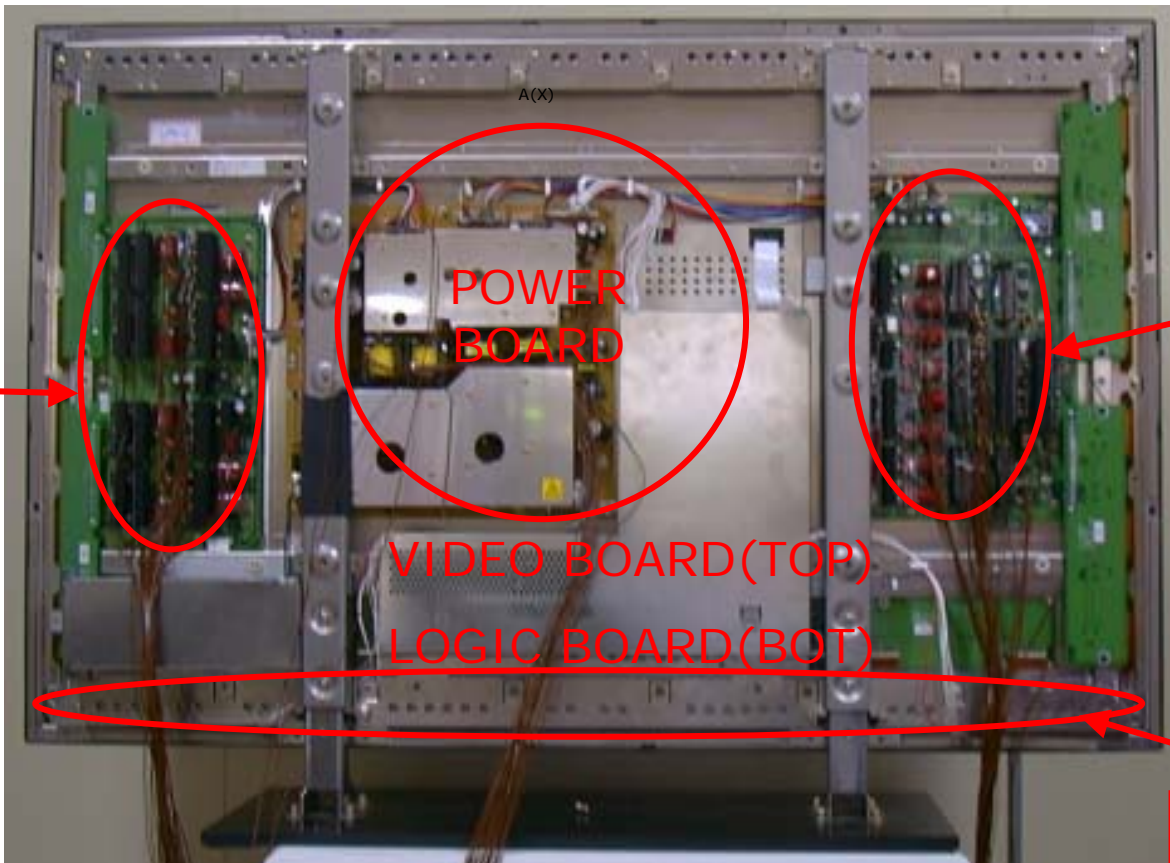
TFT module



TFT backlight



The heat source of PDP



Y
SUSTAIN
BOARD

A(X)
POWER
BOARD

X
SUSTAIN
BOARD

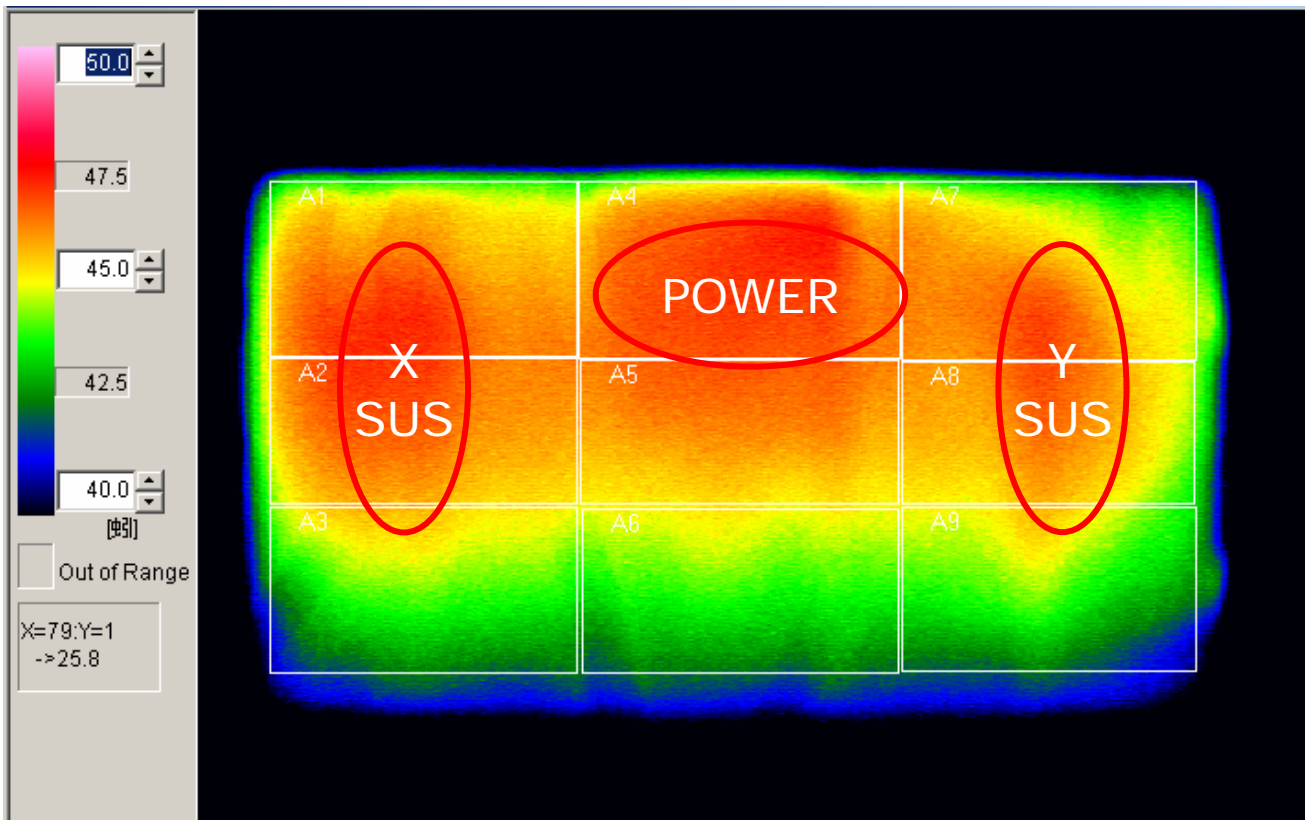
VIDEO BOARD (TOP)
LOGIC BOARD (BOT)

DATA BUFFER BOARD

DATA BUFFER
BOARD



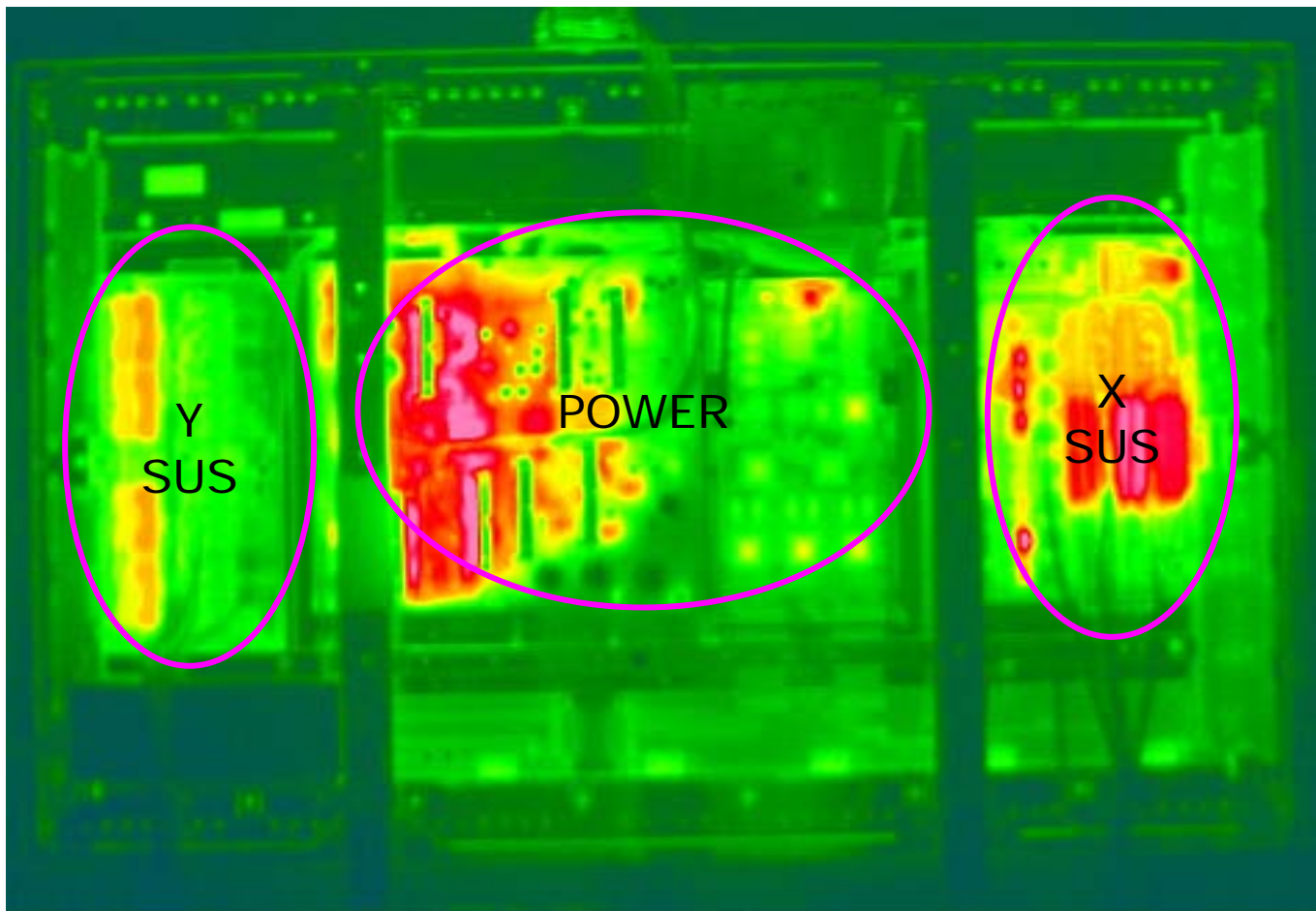
Temp. distribution - panel



Area	A1	A2	A3	A4	A5	A6	A7	A8	A9
Avg. T ()	45.4	46.1	43.8	46.4	45.9	43.7	45.3	45.6	43.5
Highest T ()	47.6	47.4	46	47.5	47.2	45.5	47.2	47	46



Temp. distribution - circuit

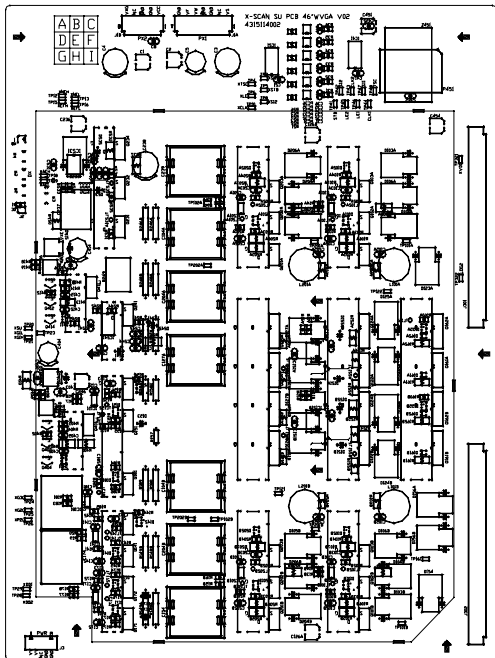




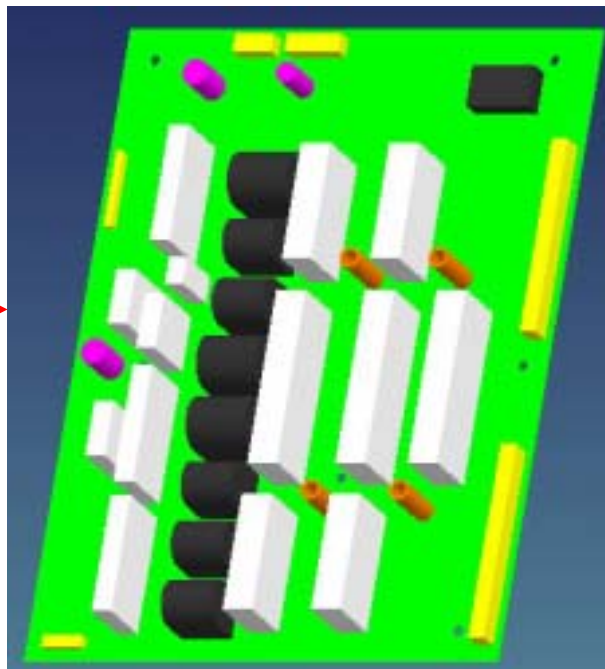
Thermal issue on Sustain driving circuit and Power supply



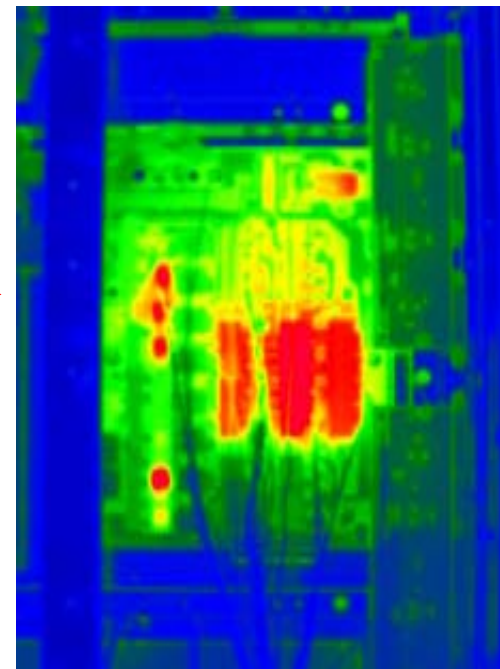
X Sustain 熱對策之設計步驟



Electrical Design
- Protel



Mechanical Design
- Pro/E

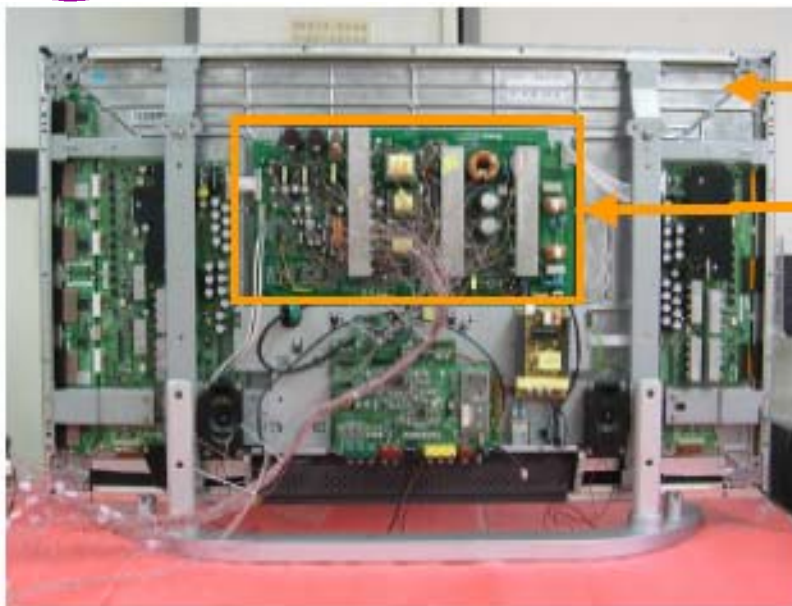


紅外線拍攝結果

Thermal Simulation
- Flotherm、ICE Pack



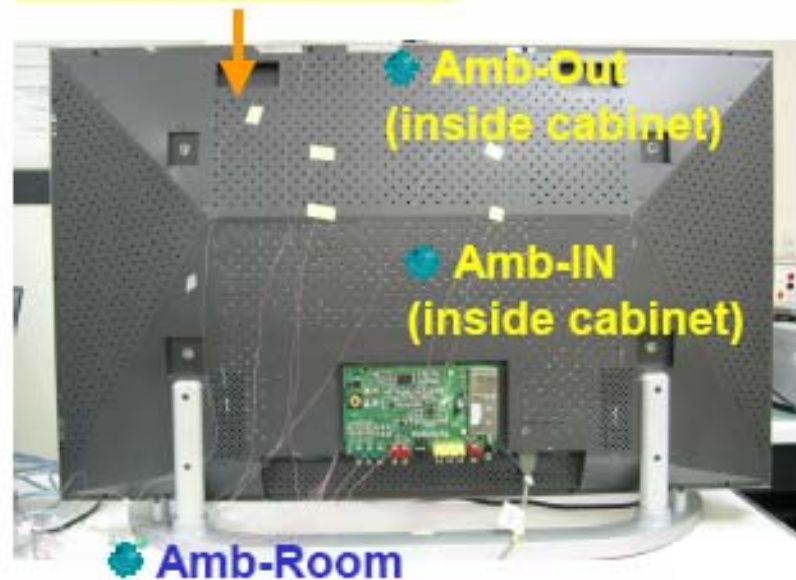
Thermal-Testing in PDP TV for PSU-A



42" PDP

Power Supply
445mmx245mmx47mm

Back Cabinet



Test Condition :

- Input Power 378W @ 110Vac
- PDP Pattern – Snow Window



Dummy load and real load testing



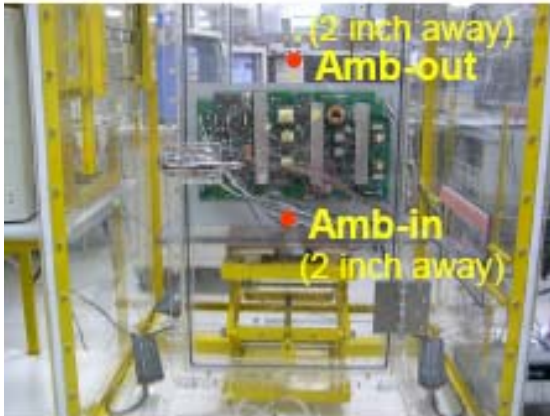
Output Power Control
by DC Load



Output Power Control
by PDP Pattern



Component temperature measurement



PSU in Free Convection Chamber (@ 55°C amb.)



Temperature Control at 55°C in the Chamber



PSU in Free Convection Chamber with a Cover (@ 55°C amb.)

- to simulate the back cabinet



Test Condition :

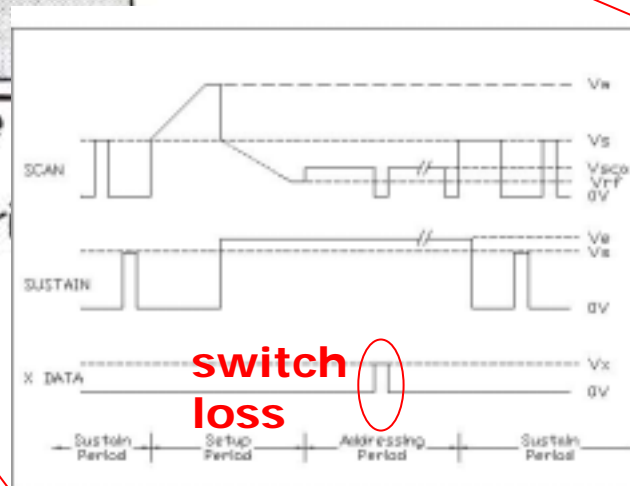
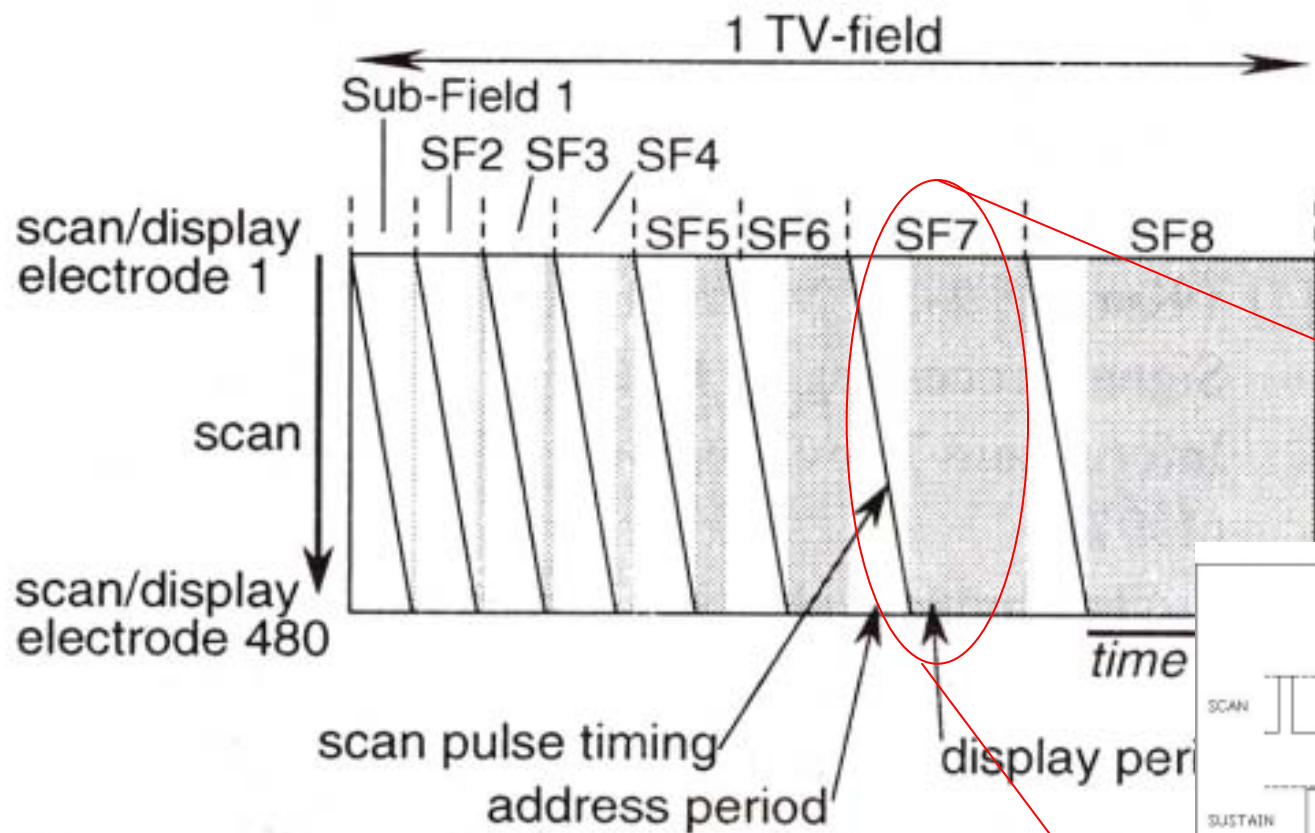
- Input Power 378W @ 110Vac
- PDP Pattern – Snow Window



Thermal issue on Data driver IC

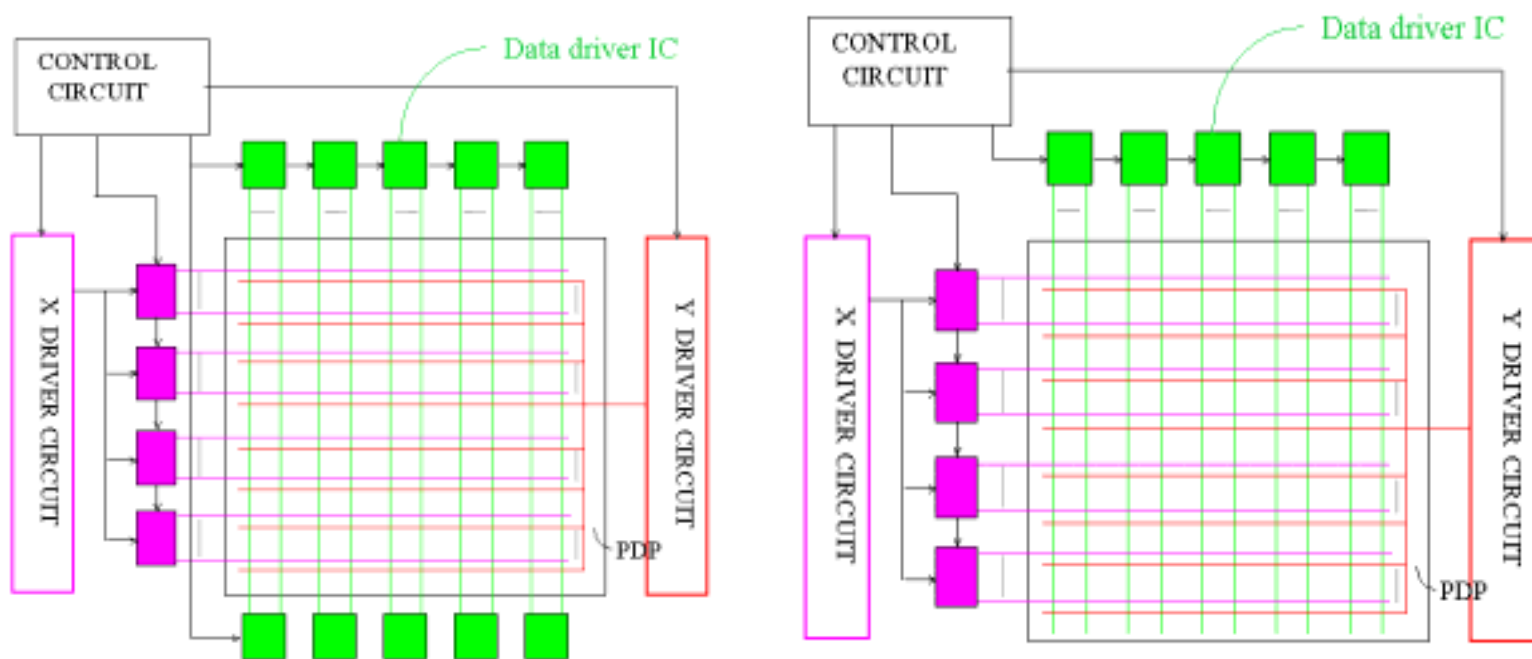


PDP driving scheme





Higher driver IC loading



Dual scan driving



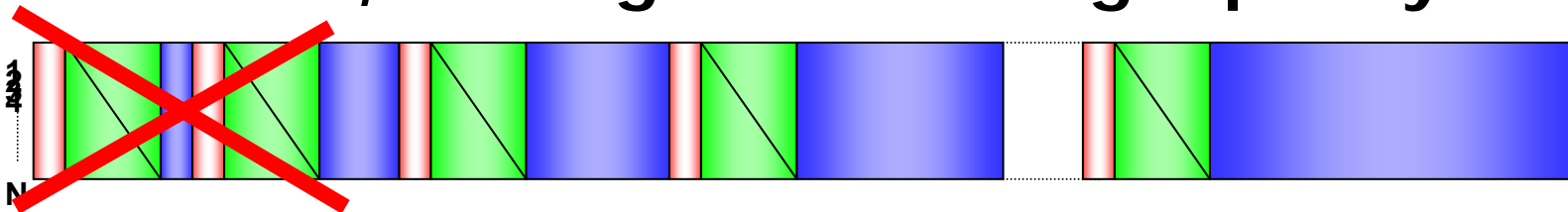
Single scan driving

Cost down, but heat?

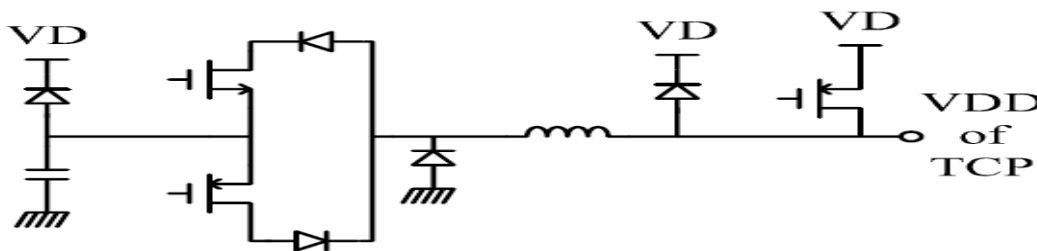


Solutions for Data IC thermal issue

- Image processing: reduce scan times, however, it brings worse image quality



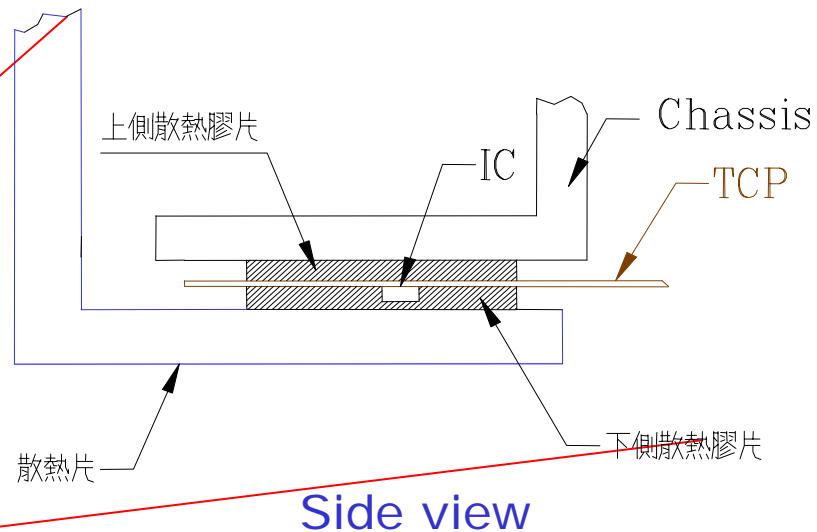
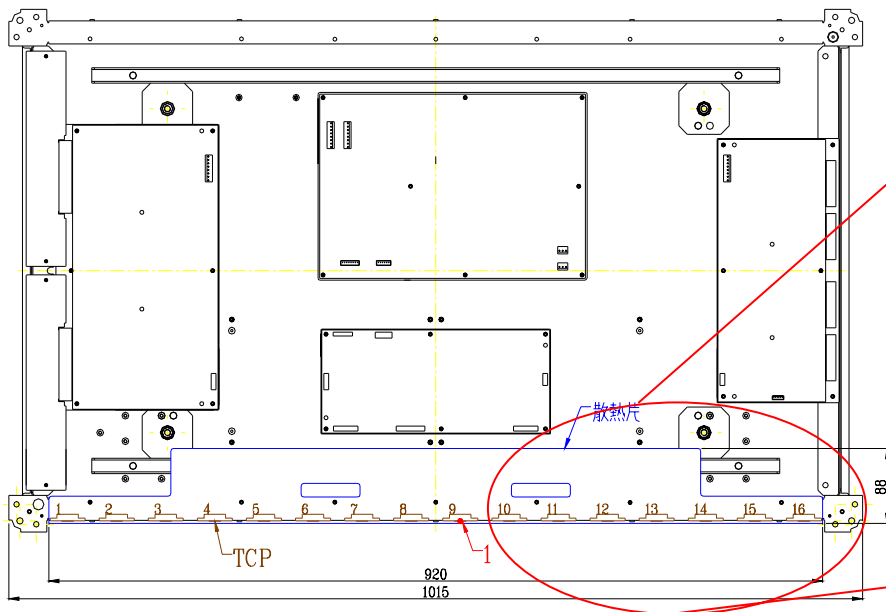
- Energy recovery circuit: get the energy back by circuit design, however, it increases cost



- Mechanical design: increase radiator area and thermal pad conductive coefficient



Radiator for Data driver IC



$$\text{Fourier's Law : } q = -kA \frac{\partial T}{\partial X}$$





SDI 102" PDP @SID2005